

ACPL-K49T

Wide Operating Temperature Automotive R²Coupler® 20-kBd Digital Optocoupler Configurable as Low-Power, Low-Leakage Phototransistor

Description

The Broadcom® ACPL-K49T is a single-channel, high-temperature, high CMR, 20-kBd digital optocoupler, configurable as a low-power, low-leakage phototransistor, specifically for use in automotive applications. The stretched SO-8 stretched package outline is designed to be compatible with standard surface mount processes.

This digital optocoupler uses an insulating layer between the light emitting diode and an integrated photo detector to provide electrical insulation between input and output. Separate connections for the photodiode bias and output transistor collector increase the speed up to a hundred times over that of a conventional phototransistor coupler by reducing the base-collector capacitance.

The Broadcom R²Coupler isolation product provides reinforced insulation and reliability that delivers safe signal isolation critical in automotive and high-temperature industrial applications.

Features

- High-temperature and reliability low-speed digital interface for automotive application
- 30 kV/μs high common-mode rejection at $V_{CM} = 1500V$ (typ)
- Low-power, low-leakage phototransistor in a 4-pin configuration
- Compact, auto-insertable stretched SO8 packages
- Qualified to AEC Q100 Grade 1 test guidelines
- Wide temperature range: $-40^{\circ}C$ to $+125^{\circ}C$
- Low LED drive current: 4 mA (typ)
- Low propagation delay: 20 μs (max)
- Worldwide safety approval:
 - UL 1577 approval, 5 kV_{rms}/1 min.
 - CSA approval
 - IEC/EN/DIN EN 60747-5-5

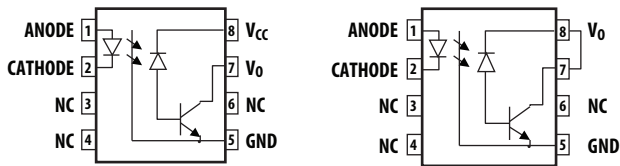
Applications

- Automotive low-speed digital signal isolation interface
- Inverter fault feedback signal isolation
- Switching power supplies feedback circuit

CAUTION!

It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD. The components featured in this data sheet are not to be used in military or aerospace applications or environments..

Functional Diagram



NOTE: The connection of a 0.1-μF bypass capacitor between pins 5 and 8 is recommended for 5-pin configuration. Pins 7 and 8 are externally shorted for 4-pin configuration.

Truth Table

LED	V ₀
ON	LOW
OFF	HIGH

Ordering Information

Specify part number followed by option number (if desired).

Part Number	Option (RoHS Compliant)	Package	Surface Mount	Tape and Reel	UL 5000 V _{rms} /1 Minute Rating	IEC/EN/DIN EN 60747-5-5	Quantity
ACPL-K49T	-000E	Stretched SO-8	X		X		80 per tube
	-060E		X		X	X	80 per tube
	-500E		X	X	X		1000 per reel
	-560E		X	X	X	X	1000 per reel

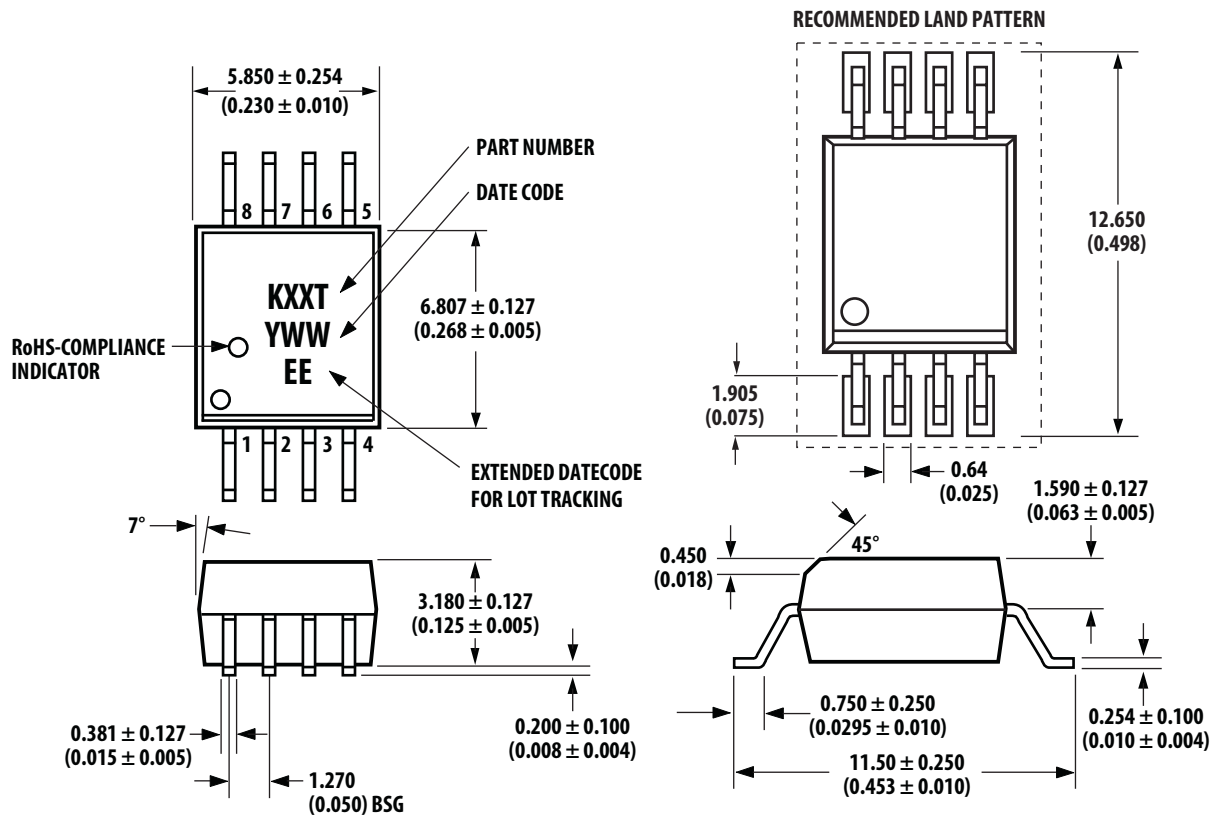
To order, choose a part number from the part number column and combine with the desired option from the option column to form an order entry.

Example 1:

ACPL-K49T-560E to order product of SSO-8 Surface Mount package in Tape and Reel packaging with IEC/EN/DIN EN 60747-5-5 Safety Approval in RoHS compliant.

Option data sheets are available. Contact your Broadcom sales representative or authorized distributor for information.

Outline Drawing (Stretched SO8)



Dimensions in millimeters and (inches).

Note:

Lead coplanarity = 0.1 mm (0.004 inches).

Floating lead protrusion = 0.25mm (10mils) max.

Recommended Pb-Free IR Reflow Profile

Recommended reflow condition as per JEDEC Standard, J-STD-020 (latest revision).

NOTE: Non-halide flux should be used.

Regulatory Information

The ACPL-K49T is approved by the following organizations:

UL

Approval under UL 1577, component recognition program up to $V_{ISO} = 5 \text{ kV}_{rms}$.

CSA

Approval under CSA Component Acceptance Notice #5.

IEC/EN/DIN EN 60747-5-5

Approval under IEC/EN/DIN EN 60747-5-5.

Insulation and Safety Related Specifications

Parameter	Symbol	ACPL-K49T	Unit	Conditions
Minimum External Air Gap (Clearance)	L(101)	8	mm	Measured from input terminals to output terminals, shortest distance through air.
Minimum External Tracking (Creepage)	L(102)	8	mm	Measured from input terminals to output terminals, shortest distance path along body.
Minimum Internal Plastic Gap (Internal Clearance)		0.08	mm	Through insulation distance conductor to conductor, usually the straight line distance thickness between the emitter and detector.
Tracking Resistance (Comparative Tracking Index)	CTI	175	V	DIN IEC 112/VDE 0303 Part 1.
Isolation Group (DIN VDE0109)		IIIa		Material Group (DIN VDE 0109).

IEC/EN/DIN EN 60747-5-5 Insulation Related Characteristic (Option 060E and 560E)

Description	Symbol	Characteristic	Unit
Installation classification per DIN VDE 0110/1.89, Table 1 For rated mains voltage $\leq 150 V_{rms}$ For rated mains voltage $\leq 300 V_{rms}$ For rated mains voltage $\leq 450 V_{rms}$ For rated mains voltage $\leq 600 V_{rms}$ For rated mains voltage $\leq 1000 V_{rms}$		I-IV I-IV I-IV I-IV I-III	
Climatic Classification		55/100/21	
Pollution Degree (DIN VDE 0110/1.89)		2	
Maximum Working Insulation Voltage	V_{IORM}	1140	V_{PEAK}
Input to Output Test Voltage, Method b $V_{IORM} \times 1.875 = V_{PR}$, 100% Production Test with $t_m = 1$ sec Partial Discharge < 5 pC	V_{PR}	2137	V_{PEAK}
Input to Output Test Voltage, Method a $V_{IORM} \times 1.6 = V_{PR}$, Type and sample test, $t_m = 10$ sec, Partial Discharge < 5 pC	V_{PR}	1824	V_{PEAK}
Highest Allowable Overvoltage (Transient Overvoltage, $t_{ini} = 60$ sec)	V_{IOTM}	8000	V_{PEAK}
Safety Limiting Values (Maximum values allowed in the event of a failure) Case Temperature Input Current Output Power	T_S $I_{S,INPUT}$ $P_{S,OUTPUT}$	175 230 600	$^{\circ}C$ mA mW
Insulation Resistance at T_S , $V_{IO} = 500V$	R_S	10^9	Ω

Absolute Maximum Ratings

Parameter		Symbol	Min.	Max.	Unit
Storage Temperature		T_S	−55	150	°C
Operating Temperature		T_A	−40	125	°C
Lead Soldering Cycle	Temperature		—	260	°C
	Time		—	10	s
Average Forward Input Current		$I_{F(avg)}$	—	20	mA
Peak Forward Input Current (50% duty cycle, 1-ms pulse width)		$I_{F(peak)}$	—	40	mA
Peak Transient Input Current ($\leq 1\text{-}\mu\text{s}$ pulse width, 300 ps)		$I_{F(trans)}$	—	100	mA
Reversed Input Voltage		V_R	—	5	V
Input Power Dissipation		P_{IN}	—	30	mW
Output Power Dissipation		P_O	—	100	mW
Average Output Current		I_O	—	8	mA
Peak Output Current		$I_{O(pk)}$	—	16	mA
Supply Voltage		V_{CC}	−0.5	30	V
Output Voltage		V_O	−0.5	20	V

Recommended Operating Conditions

Parameter	Symbol	Min.	Max.	Unit
Supply Voltage	V_{CC}	—	20.0	V
Operating Temperature	T_A	−40	125	°C

Electrical Specifications (DC) for 5-Pin Configuration

Over recommended operating $T_A = -40^{\circ}\text{C}$ to 125°C , unless otherwise specified.

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions		Fig.	Note	
Current Transfer Ratio	CTR	32	65	100	%	T _A = 25° C	V _{CC} = 4.5V, V _O = 0.5V, I _F = 10 mA	1, 2, 4	a	
		24	65	—						
		65	110	150		T _A = 25° C	V _{CC} = 4.5V, V _O = 0.5V, I _F = 4 mA	1, 2, 4		
		50	110	—						
Logic Low Output Voltage	V _{OL}	—	0.1	0.5	V		V _{CC} = 4.5V, I _F = 10 mA, I _o = 2.4 mA	3		
		—	0.1	0.5			V _{CC} = 4.5V, I _F = 4 mA, I _o = 2.0 mA			
Logic High Output Current	I _{OH}	—	2 x 10 ⁻⁴	0.5	μA	T _A = 25° C	V _O = V _{CC} = 5.5V	I _F = 0 mA	7	
		—	4 x 10 ⁻⁴	5			V _O = V _{CC} = 20V			
Logic Low Supply Current	I _{CCL}	—	35	100	μA		I _F = 4 mA, V _O = open, V _{CC} = 20V			
Logic High Supply Current	I _{CCH}	—	0.02	1	μA	T _A = 25° C	I _F = 0 mA, V _O = open, V _{CC} = 20V			
		—	—	2.5	μA					
Input Forward Voltage	V _F	1.4	1.5	1.7	V	T _A = 25°C	I _F = 4 mA		6	
		1.2	1.5	1.8	V					
Input Reversed Breakdown Voltage	BV _R	5	—	—	V		I _R = 10 μA			
Temperature Coefficient of Forward Voltage	ΔV/ΔT _A	—	-1.5	—	mV/°C		I _F = 10 mA			
Input Capacitance	C _{IN}	—	90	—	pF		F = 1 MHz, V _F = 0V			

a. Current Transfer Ratio in percent is defined as the ratio of output collector current, I_O , to the forward LED input current, I_F , times 100.

Switching Specifications (AC) for 5-Pin Configuration

Over recommended operating ($T_A = -40^{\circ}\text{C}$ to 125°C), $V_{CC} = 5.0\text{V}$ unless otherwise specified.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions		Fig.	Note
Propagation Delay Time to Logic Low at Output	t_{PHL}	—	—	20	μs	Pulse: $f = 10\text{kHz}$, Duty cycle = 50%, $I_F = 4\text{mA}$, $V_{CC} = 5.0\text{V}$, $R_L = 8.2\text{k}\Omega$, $C_L = 15\text{pF}$, $V_{THHL} = 1.5\text{V}$		9	
Propagation Delay Time to Logic High at Output	t_{PLH}	—	—	20	μs	Pulse: $f = 10\text{kHz}$, Duty cycle = 50%, $I_F = 4\text{mA}$, $V_{CC} = 5.0\text{V}$, $R_L = 8.2\text{k}\Omega$, $C_L = 15\text{pF}$, $V_{THLH} = 2.0\text{V}$		9	
Common Mode Transient Immunity at Logic High Output	$ CM_H $	15	30	—	kV/ μs	$I_F = 0\text{mA}$	$V_{CM} = 1500\text{V}_{p-p}$, $T_A = 25^{\circ}\text{C}$ $R_L = 1.9\text{k}\Omega$	10	a
Common Mode Transient Immunity at Logic Low Output	$ CM_L $	15	30	—	kV/ μs	$I_F = 10\text{mA}$			
Common Mode Transient Immunity at Logic Low Output	$ CM_L $	—	15	—	kV/ μs	$I_F = 4\text{mA}$	$V_{CM} = 1500\text{V}_{p-p}$, $T_A = 25^{\circ}\text{C}$ $R_L = 8.2\text{k}\Omega$		

a. Common transient immunity in a Logic High level is the maximum tolerable (positive) dV_{CM}/dt on the rising edge of the common mode pulse, V_{CM} , to assure that the output will remain in a Logic High state (i.e., $V_O > 2.0\text{V}$). Common mode transient immunity in a Logic Low level is the maximum tolerable (negative) dV_{CM}/dt on the falling edge of the common mode pulse signal, V_{CM} , to assure that the output will remain in a Logic Low state (i.e., $V_O < 0.8\text{V}$).

Electrical Specifications (DC) for 4-Pin Configuration

Over recommended operating $T_A = -40^{\circ}\text{C}$ to 125°C , unless otherwise specified.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions	Fig.	Note
Current Transfer Ratio	CTR	70	130	210	%	$T_A = 25^{\circ}\text{C}$, $V_{CC} = V_O = 5\text{V}$, $I_F = 4\text{ mA}$	4	a
Current Transfer Ratio	CTR (Sat)	24	60	—		$I_F = 10\text{ mA}$, $V_{CC} = V_O = 0.5\text{V}$	5	
		35	110	—		$I_F = 4\text{ mA}$		
Logic Low Output Voltage	V_{OL}	—	0.1	0.5	V	$I_F = 10\text{ mA}$, $I_O = 2.4\text{ mA}$	5	
		—	0.1	0.5		$I_F = 4\text{ mA}$, $I_O = 1.4\text{ mA}$		
Off-State Current	$I_{(CEO)}$	—	4×10^{-4}	5	μA	$V_O = V_{CC} = 20\text{V}$, $I_F = 0\text{ mA}$	8	
Input Forward Voltage	V_F	1.4	1.5	1.7	V	$T_A = 25^{\circ}\text{C}$, $I_F = 4\text{ mA}$	6	
		1.2	1.5	1.8	V			
Input Reversed Breakdown Voltage	BV_R	5	—	—	V	$I_R = 10\text{ }\mu\text{A}$		
Temperature Coefficient of Forward Voltage	$\Delta V/\Delta T_A$	—	-1.5	—	$\text{mV}/^{\circ}\text{C}$	$I_F = 10\text{ mA}$		
Input Capacitance	C_{IN}	—	90	—	pF	$F = 1\text{ MHz}$, $V_F = 0\text{V}$		
Output Capacitance	C_{CE}	—	35	—	pF	$F = 1\text{ MHz}$, $V_F = 0\text{V}$, $V_O = V_{CC} = 0\text{V}$		

a. Current Transfer Ratio in percent is defined as the ratio of output collector current, I_O , to the forward LED input current, I_F , times 100.

Switching Specifications (AC) for 4-Pin Configuration

Over recommended operating ($T_A = -40^{\circ}\text{C}$ to 125°C), $V_{CC} = 5.0\text{V}$ unless otherwise specified.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions	Fig.	Note
Propagation Delay Time to Logic Low at Output	t_{PHL}	—	2	100	μs	Pulse: $f = 1\text{ kHz}$, Duty cycle = 50%, $I_F = 4\text{ mA}$, $V_{CC} = 5.0\text{V}$, $R_L = 8.2\text{ k}\Omega$, $C_L = 15\text{ pF}$, $V_{THHL} = 1.5\text{V}$	10	
Propagation Delay Time to Logic High at Output	t_{PLH}	—	19	100	μs	Pulse: $f = 1\text{ kHz}$, Duty cycle = 50%, $I_F = 4\text{ mA}$, $V_{CC} = 5.0\text{V}$, $R_L = 8.2\text{ k}\Omega$, $C_L = 15\text{ pF}$, $V_{THLH} = 2.0\text{V}$	10	
Common Mode Transient Immunity at Logic Low Output	$ CM_L $	15	30	—	$\text{kV}/\mu\text{s}$	$I_F = 0\text{ mA}$, $V_{CM} = 1500\text{ V}_{p-p}$, $T_A = 25^{\circ}\text{C}$, $R_L = 8.2\text{ k}\Omega$	12	a
Common Mode Transient Immunity at Logic Low Output	$ CM_L $	15	30	—	$\text{kV}/\mu\text{s}$	$I_F = 4\text{ mA}$, $V_{CM} = 1500\text{ V}_{p-p}$, $T_A = 25^{\circ}\text{C}$, $R_L = 8.2\text{ k}\Omega$		

a. Common transient immunity in a Logic High level is the maximum tolerable (positive) dV_{CM}/dt on the rising edge of the common mode pulse, V_{CM} , to assure that the output will remain in a Logic High state (i.e., $V_O > 2.0\text{V}$). Common mode transient immunity in a Logic Low level is the maximum tolerable (negative) dV_{CM}/dt on the falling edge of the common mode pulse signal, V_{CM} , to assure that the output will remain in a Logic Low state (i.e., $V_O < 0.8\text{V}$).

Package Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	Fig.	Note
Input-Output Momentary Withstand Voltage ^a	V _{ISO}	5000	—	—	V _{rms}	RH ≤ 50%, t = 1 min; T _A = 25°C		b, c
Input-Output Resistance	R _{I-O}	—	10 ¹⁴	—	Ω	V _{I-O} = 500 V _{dc}		b
Input-Output Capacitance	C _{I-O}	—	0.6	—	pF	f = 1 MHz; V _{I-O} = 0 V _{dc}		b

- The Input-Output Momentary Withstand Voltage is a dielectric voltage rating that should not be interpreted as an input-output continuous voltage rating.
- Device considered a two-terminal device: pins 1, 2, 3 and 4 shorted together, and pins 5, 6, 7 and 8 shorted together.
- In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage >6000 V_{rms} for 1 second.

Figure 1: Current Transfer Ratio vs. Input Current

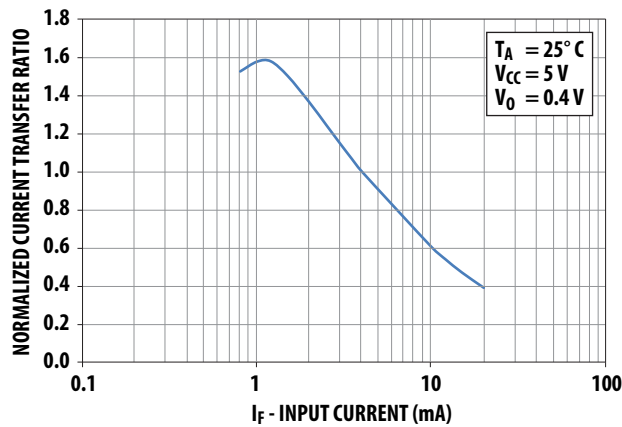


Figure 2: Normalized Current Transfer Ratio vs. Temperature

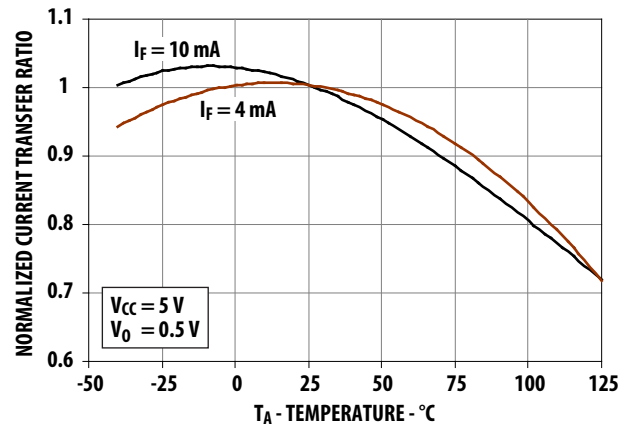


Figure 3: Typical Low-Level Output Current vs Output Voltage

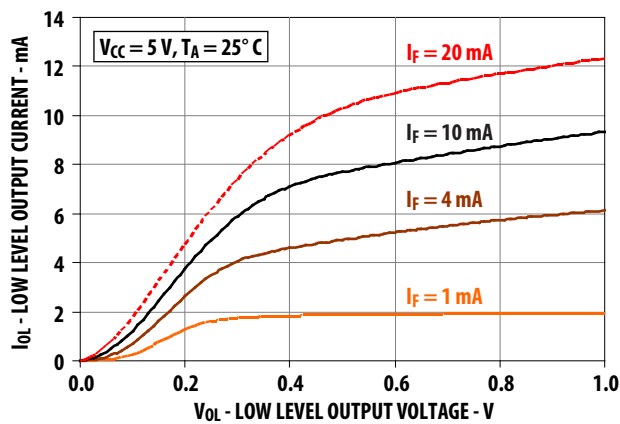


Figure 4: Output Current vs Output Voltage (4-Pin Configuration)

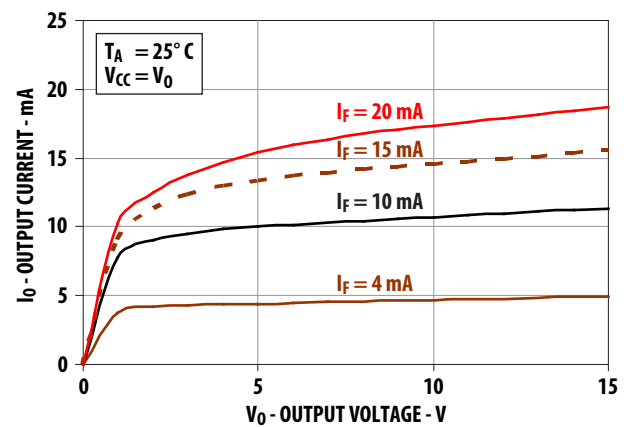


Figure 5: Typical Low-Level Output Current vs Output Voltage (4-Pin Configuration)

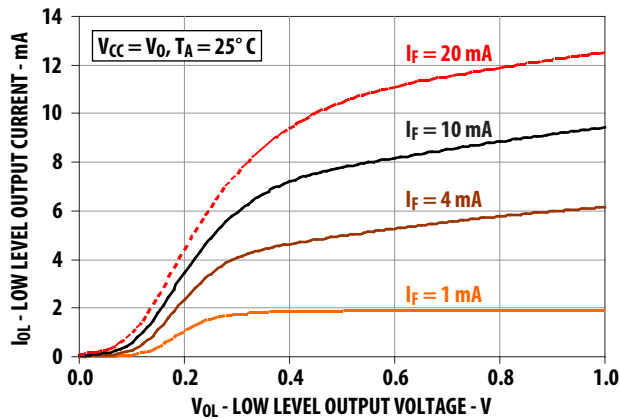


Figure 6: Typical Input Current vs Forward Voltage

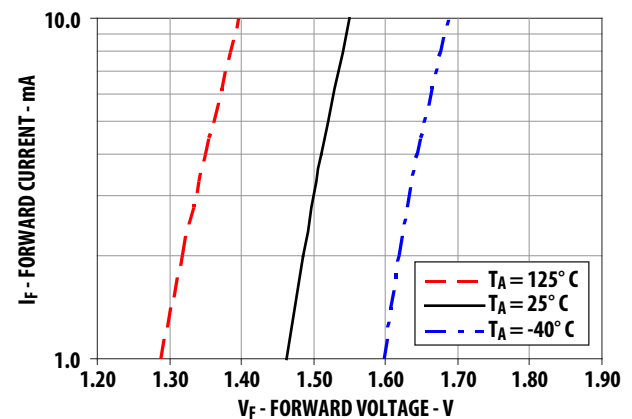


Figure 7: Typical High-Level Output Current vs Temperature

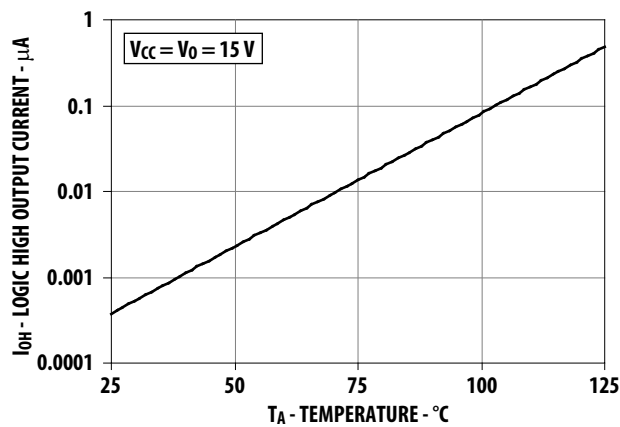


Figure 8: Typical Off-State Current vs Temperature (4-Pin Configuration)

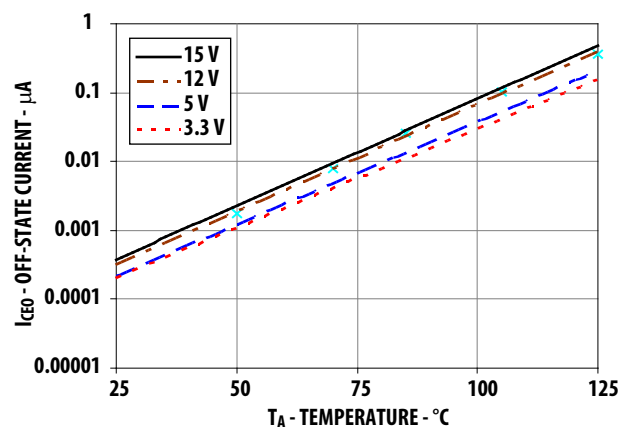


Figure 9: Switching Test Circuit (5-Pin Configuration)

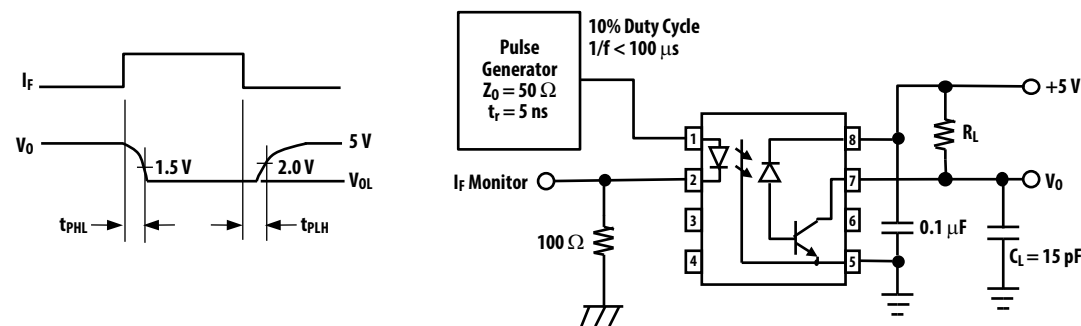


Figure 10: Switching Test Circuit (4-Pin Configuration)

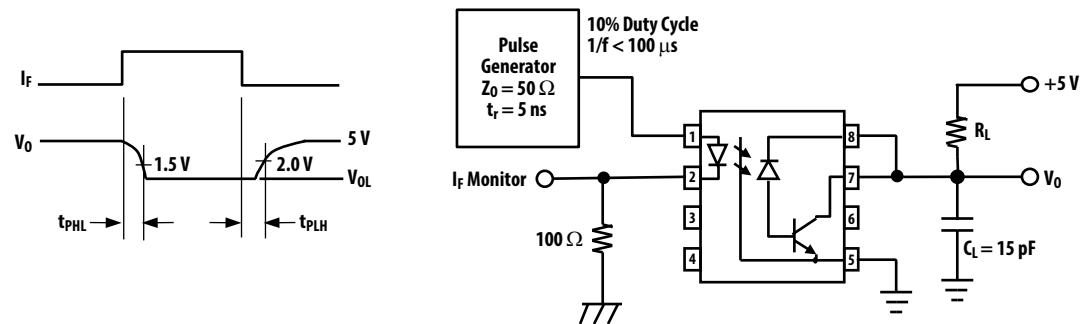


Figure 11: Test Circuit for Transient Immunity and Typical Waveforms (5-Pin Configuration)

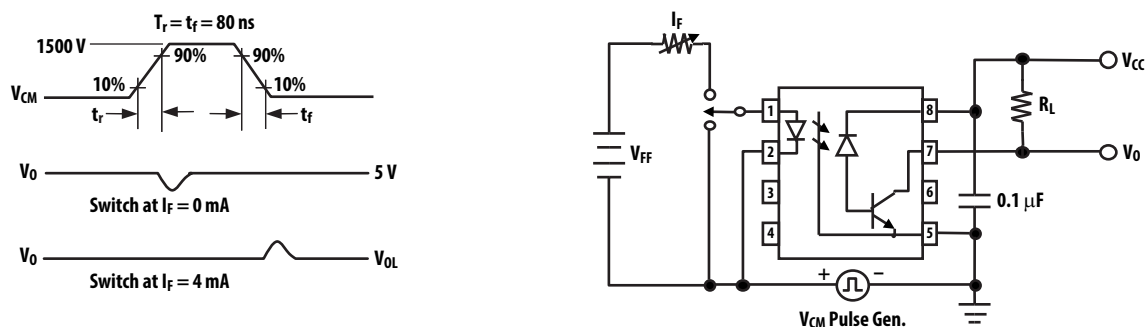
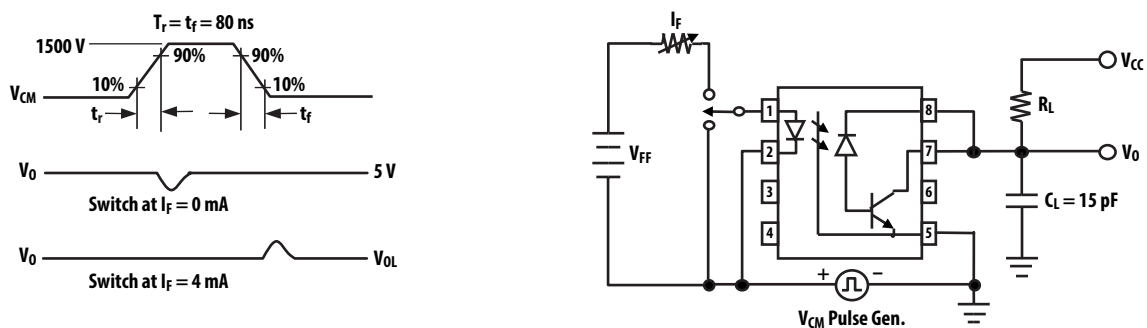


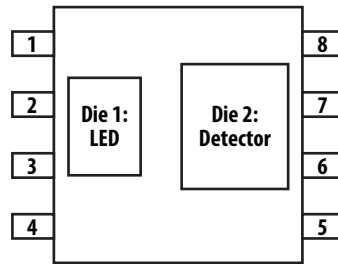
Figure 12: Test Circuit for Transient Immunity and Typical Waveforms (4-Pin Configuration)



Thermal Resistance Model for ACPL-K49T

The diagram of ACPL-K49T for measurement is shown in Figure 13. Here, one die is heated first and the temperatures of all the dice are recorded after thermal equilibrium is reached. Then, the second die is heated and all the dice temperatures are recorded. With the known ambient temperature, the die junction temperature and power dissipation, the thermal resistance can be calculated. The thermal resistance calculation can be cast in matrix form. This yields a 2-by-2 matrix for our case of two heat sources.

Figure 13: Diagram of ACPL-K49T for Measurement



$$\begin{bmatrix} R_{11} & R_{12} \\ R_{12} & R_{22} \end{bmatrix} \times \begin{bmatrix} P_1 \\ P_2 \end{bmatrix} = \begin{bmatrix} \Delta T_1 \\ \Delta T_2 \end{bmatrix}$$

R_{11} : Thermal Resistance of Die1 due to heating of Die1

R_{12} : Thermal Resistance of Die1 due to heating of Die2.

R_{21} : Thermal Resistance of Die2 due to heating of Die1.

R_{22} : Thermal Resistance of Die2 due to heating of Die2.

P_1 : Power dissipation of Die1 (W).

P_2 : Power dissipation of Die2 (W).

T_1 : Junction temperature of Die1 due to heat from all dice (°C).

T_2 : Junction temperature of Die2 due to heat from all dice.

T_a : Ambient temperature.

ΔT_1 : Temperature difference between Die1 junction and ambient (°C).

ΔT_2 : Temperature difference between Die2 junction and ambient (°C).

$$T_1 = (R_{11} \times P_1 + R_{12} \times P_2) + T_a$$

$$T_2 = (R_{21} \times P_1 + R_{22} \times P_2) + T_a$$

Measurement data on a low K board:

$$R_{11} = 160^\circ\text{C/W}, R_{12} = R_{21} = 74^\circ\text{C/W}, R_{22} = 115^\circ\text{C/W}$$

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